



Ohio Land Improvement Contractors Association

The Ohio Affiliate of the Land Improvement Contractors of America
1122 Somerlot Hoffman Rd. E. Marion, OH 43302
Phone: 740-751-4703 Fax: 740-751-4704
email: OhioLICA@landstewards.com
www.olica.org

Date: June 10, 2011

To: Ohio LICA Members

Fr: Roger Greenawalt, President
Mark Wilson, Executive Director

Re: 2011 Ohio LICA Scholarship

The Board of Directors of the Ohio Land Improvement Contractors Association is pleased to announce the availability of a limited number of academic scholarships. Criteria includes:

- **Student Eligibility:** Children and grandchildren of current OLICA members. Each applicant must be sponsored by an OLICA member in good standing. Moreover, applicants must be either a 2011 high school graduate or a student planning to enroll or is currently enrolled in an accredited two- or four-year secondary learning institution during the 2011-12 academic year.
- **Number and Dollar Amount of Scholarships Awarded:** 1-7 scholarships, \$300 minimum - \$1000 maximum.
- **Award Period:** Scholarships can be used for tuition, books and fees at any accredited two- or four-year secondary learning institution during the 2011-12 academic year.
- **Area of Study:** Scholarships can be used by the recipient studying in any course of study at any accredited two- or four-year secondary learning institution.
- **Grade Requirements:** The recipient must maintain a minimum 2.5 GPA during the first half of the 2011-12 academic year.
- **Award Date:** The award will be presented to the recipient on January 4, 2012 at the Ohio LICA Annual Banquet. Recipients must be in attendance in order to receive their award.
- **Application Deadline:** Postmarked on or before Friday, August 19, 2011.

Attached to this cover letter is the scholarship application. Please forward this material to eligible students as soon as possible. Thank you.



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2011 OLICA Scholarship Application

Applicant Name: _____

Home Address: _____

City: _____ State: _____ Zip: _____

Home Phone: _____ E-Mail: _____

Parents: _____

OLICA Member Sponsor: _____

Education & Accomplishments

High School: _____

Address: _____

City: _____ State: _____ Zip: _____

Graduation Date: _____ Cumulative GPA: _____

Organizations, Clubs and Special Activities: _____

Honors, Recognition and Awards: _____

College/Technical School: _____

Address: _____

City: _____ State: _____ Zip: _____

Graduation Date: _____ Cumulative GPA: _____

Organizations, Clubs and Special Activities: _____

Honors, Recognition and Awards: _____

Supporting Materials and References

In order for an application to be given full consideration, the following supporting materials must be included:

- **Letters of Recommendation:** Three (3) letters from adult leaders, mentors and/or educators describing the applicant's academic accomplishments, community service and/or leadership experiences. Letters may not be written by the applicant, anyone under 21 years of age, the OLICA member sponsor, or anyone related to the applicant or serving as a legal guardian. Contact information (at least one phone number) should be included for each reference.
- **Essay:** In 500 words or less, describe your academic, vocational and personal career goals and how this scholarship can help you accomplish your goals.
- **Transcripts:** A copy of your most recent high school, college or technical school transcripts.
- **Photo:** A relatively current wallet-size photograph.

Mail your application and supporting materials to: *The Ohio Land Improvement Contractors Association (OLICA), 1122 Somerlot Hoffman Rd. E., Marion, OH 43302.*

All applications must be postmarked on or before Friday, August 19, 2011.